

Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1-24. (Canceled).

C' 1. ~~25.~~ (New) A flexible printed wiring board comprising:

a metal film before patterning,

a resin coating on said metal film,

an opening formed in said resin coating, and

a metal bump located in said opening, connected at its bottom face to said metal film and having a height greater than the thickness of said resin coating,

wherein said resin coating is removed at the portion located at a top face of said metal bump and the top face of said metal bump is exposed from the surface of said resin coating.

2. ~~26.~~ (New) The flexible printed wiring board according to claim ~~25,~~¹

wherein said resin coating have a first resin coating made of rigid resin close contacted to said metal film, and a second resin coating having adhesive close contacted to said first resin coating.

3. ~~27.~~ (New) A flexible printed wiring board comprising:

a metal film,

a resin coating on said metal film,

an opening formed in said resin coating, and

a metal bump located in said opening, connected at its bottom face to said metal film and having a height greater than the thickness of said resin coating,

wherein said resin coating is removed at the portion located at a top face of said metal bump and the top face of said metal bump is exposed from the surface of said resin coating,

wherein said resin coating have a first resin coating made of rigid resin close contacted to said metal film, and a second resin coating having adhesive close contacted to said first resin coating, and said second resin coating is exposed.

4. ~~28~~ (New) The flexible printed wiring board according to claim ~~27~~³ wherein said metal film is patterned in a predetermined form.

5. ~~29~~ (New) The flexible printed wiring board according to claim ~~28~~⁴, wherein an electric device is mounted on said flexible printed wiring board and a bonding pad of said electric device is connected with the front face of said metal bump.
